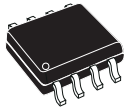


100 V, precision, bidirectional current sense amplifier



SO8



MiniSO8

Maturity status link

[TSC2020, TSC2021, TSC2022](#)

Features

- Wide common-mode voltage: -4 to 100 V
- High common-mode rejection CMR: 100 dB min.
- Offset voltage: $\pm 150 \mu\text{V}$ max.
- Offset drift: $0.5 \mu\text{V}/^\circ\text{C}$ max.
- Enhanced PWM rejection
- 2.7 to 5.5 V supply voltage
- Internal fixed gain
 - TSC2020: 20 V/V
 - TSC2021: 50 V/V
 - TSC2022: 100 V/V
- Gain error: 0.3% max.
- Gain drift: $3.5 \text{ ppm}/^\circ\text{C}$ max.
- SO8 and MiniSO8 package
- AEC-Q100 qualified

Applications

- High-side/low-side current sensing
- Battery management system
- 48 V power distribution
- 48 V power tools
- Motor control
- Automotive

Description

TSC2020, TSC2021 and TSC2022 are a series of precision bidirectional current sense amplifier. They can sense current via a shunt resistor over a wide range of common-mode voltages, from -4 to +100 V, whatever the supply voltage is. It is able to sense very low drop voltages, minimizing measurement error.

TSC2020, TSC2021 and TSC2022 are current sense amplifiers that may be used for various functions like precision current measurement, overcurrent protection, current monitoring, and feedback loops. These devices fully operate over the supply voltage range of 2.7 to 5.5 V, and over an ambient temperature range of -40 to 125 °C.

1 Block diagram and pin description

Figure 1. Block diagram

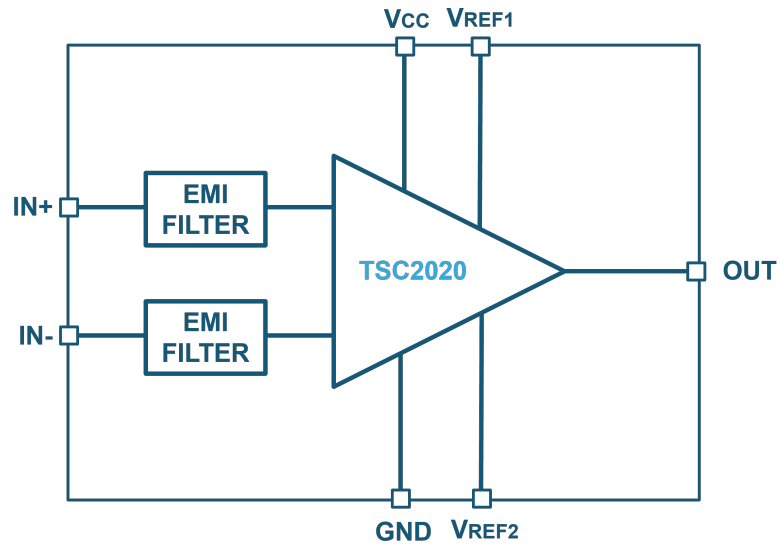


Figure 2. Pin connections (top view)

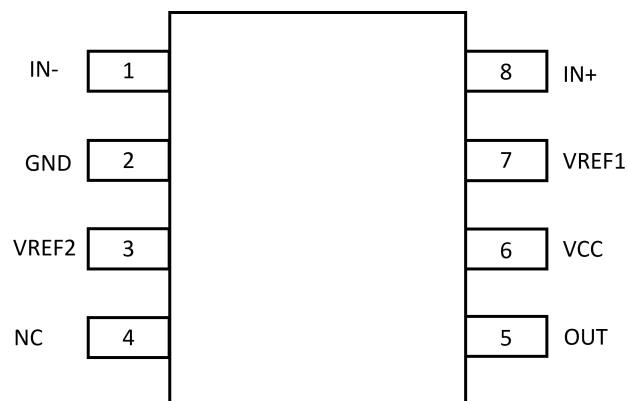


Table 1. Pin description

Pin	Pin name	Description
1	IN-	Negative input
2	GND	Ground
3	VREF2	Reference voltage 2
4	NC	Not connected
5	OUT	Output
6	VCC	Supply voltage
7	VREF1	Reference voltage 1
8	IN+	Positive input

2 Absolute maximum ratings and operation conditions

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage ⁽¹⁾	-0.3 to 5.8	V
V_{ICM}	Common-mode voltage on input pins	-5 to 105	V
V_{DIF}	Differential voltage between input pins (IN+, IN-)	±70	V
V_{REF1} , V_{REF2} , V_{OUT}	Voltage present on pins REF1, REF2, and OUT	GND - 0.3 to $V_{CC} + 0.3$	V
I_{IN}	Input current on V_{IN+} , V_{IN-} ⁽²⁾	1.5	mA
T_J	Junction temperature	150	°C
T_{STG}	Storage temperature	-65 to 150	°C
ESD	Human body model (HBM) ⁽³⁾	2000	V
	Charged device model (CDM) ⁽⁴⁾		
	SO8	750	V
	MiniSO8	1000	
R_{THJA}	Thermal resistance junction to ambient ⁽⁵⁾⁽⁶⁾		
	SO8	125	°C/W
	MiniSO8	190	

1. All voltage values, except the differential voltage, are with respect to the network ground terminal.
2. Input voltage can go beyond the supply voltage, but input current must be limited. Using a serial resistor with the input is highly recommended in that case.
3. According to JEDEC standard JESD22-A114F.
4. According to ANSI/ESD STM 5.3.1.
5. Short-circuits can cause excessive heating and destructive dissipation.
6. The RTHs are typical values.

Table 3. Operating conditions

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	2.7 to 5.5	V
V_{ICM}	Common-mode voltage on input pins	-4 to +100	V
V_{REF}	Output offset adjustment range	0 to V_{CC}	V
T	Operating free-air temperature range	-40 to 125	°C

3 Electrical characteristics

Table 4. Electrical characteristics - $V_{CC} = 2.7\text{ V}$, $V_{ICM} = 48\text{ V}$, $T = 25\text{ °C}$ (unless otherwise specified).

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Power supply						
I_{CC}	Current consumption	$V_{ICM} = -4\text{ to }100\text{ V}$ $T_{min} < T < T_{max}$		1.7	2.3 2.3	mA
Input						
$ V_{os} $	Offset voltage (RTI) ⁽¹⁾	$V_{ICM} = 12\text{ V}$, $V_{REF} = 1.35\text{ V}$ $T_{min} < T < T_{max}$			150 200	μV
		$V_{ICM} = 48\text{ V}$, $V_{REF} = 1.35\text{ V}$ $T_{min} < T < T_{max}$			400 500	
$ \Delta V_{os}/\Delta T $	Offset drift vs. temperature	$V_{ICM} = 12\text{ V}$, $T_{min} < T < T_{max}$			0.5	$\mu\text{V}/\text{°C}$
		$V_{ICM} = 48\text{ V}$, $T_{min} < T < T_{max}$			1	
CMR	Common-mode rejection	$V_{ICM} = -4\text{ to }100\text{ V}$, DC mode $T_{min} < T < T_{max}$	100 100	112		dB
I_{IB}	Input bias current	$V_{ICM} = 12\text{ V}$, $V_{sense} = 0$ $T_{min} < T < T_{max}$		100	130 140	μA
		$V_{ICM} = 48\text{ V}$, $V_{sense} = 0$ $T_{min} < T < T_{max}$		200	230 240	
$ V_{sense} $	V_{sense} operating range with $E_g \leq 0.3\%$ ⁽²⁾	TSC2020 $T_{min} < T < T_{max}$			123.8 123.6	mV
		TSC2021 $T_{min} < T < T_{max}$			49.1 48.8	
		TSC2022 $T_{min} < T < T_{max}$			24.1 23.9	
Output						
G	Gain	TSC2020 TSC2021 TSC2022		20 50 100		V/V
E_g	Gain error	$\Delta V_{OUT} = 100\text{ mV to } (V_{CC} - 100\text{ mV})$ $T_{min} < T < T_{max}$		0.01	0.3 0.35	%
$\Delta E_g/\Delta T$	Gain error drift	$T_{min} < T < T_{max}$			3.5	ppm/°C
NLE	Linearity error	$V_{ICM} = -4\text{ to }100\text{ V}$		0.01		%
$V_{CC} - V_{OH}$	Drop voltage output high	$I_{source} = 0.2\text{ mA}$ $T_{min} < T < T_{max}$		11	25 35	mV
		$I_{source} = 2\text{ mA}$ $T_{min} < T < T_{max}$		115	150 200	
V_{OL}	Output voltage low	$I_{sink} = 0.2\text{ mA}$ $T_{min} < T < T_{max}$		24	40 55	mV
		$I_{sink} = 2\text{ mA}$ $T_{min} < T < T_{max}$		200	240 390	

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_{OUT}	Output current	Sink mode	8	12.5	18	mA
		$T_{min} < T < T_{max}$	5		24	
		Source mode	10	14.5	25	
		$T_{min} < T < T_{max}$	5		30	
Reg Load	Load regulation	$I_{OUT} = -5$ to $+5$ mA		0.2	1.5	$\frac{mV}{mA}$
C_L	Maximum capacitive load	No sustained oscillation		1		nF
Offset adjustment						
R_T	V_{REF} gain	Voltage applied on one V_{REF} pin		0.5		V/V
Acc	V_{REF} gain error	One V_{REF} pin connected to V_{CC} the other to GND		0.2		%
Dynamic performances						
BW	Small signal -3 dB bandwidth	$R_L = 10$ k Ω , $C_L = 100$ pF	350	650		kHz
		$T_{min} < T < T_{max}$	350			
SR	Slew rate	$C_L = 100$ pF				V/ μ s
		TSC2020, $V_{sense} = 108$ mV	1.1	1.8		
		TSC2020, $T_{min} < T < T_{max}$	1			
		TSC2021, $V_{sense} = 43$ mV	1.5	2.4		
		TSC2021, $T_{min} < T < T_{max}$	1.4			
		TSC2022, $V_{sense} = 22$ mV	1.9	3		
		TSC2022, $T_{min} < T < T_{max}$	1.8			
E_N	Spectral density (RTI) ⁽¹⁾	$f = 1$ kHz		63		nV/ \sqrt{Hz}

1. RTI stands for "Related to input."

 2. $V_{sense} = (V_{in+}) - (V_{in-})$.

Table 5. Electrical characteristics - $V_{CC} = 5\text{ V}$, $V_{ICM} = 48\text{ V}$, $T = 25\text{ °C}$ (unless otherwise specified).

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Power supply						
I_{CC}	Current consumption	$V_{ICM} = -4\text{ to }100\text{ V}$ $T_{min} < T < T_{max}$		1.8	2.4 2.4	mA
Input						
$ V_{os} $	Offset voltage (RTI) ⁽¹⁾	$V_{ICM} = 12\text{ V}$, $V_{REF} = 2.5\text{ V}$ $T_{min} < T < T_{max}$			150 200	μV
		$V_{ICM} = 48\text{ V}$, $V_{REF} = 2.5\text{ V}$ $T_{min} < T < T_{max}$			400 500	
$ \Delta V_{os}/\Delta T $	Offset drift vs. temperature	$V_{ICM} = 12\text{ V}$, $T_{min} < T < T_{max}$			0.5	$\mu\text{V}/\text{°C}$
		$V_{ICM} = 48\text{ V}$, $T_{min} < T < T_{max}$			1	
CMR	Common-mode rejection	$V_{ICM} = -4\text{ to }100\text{ V}$, DC mode $T_{min} < T < T_{max}$	100 100	112		dB
SVR	Supply voltage rejection	$V_{CC} = 2.7\text{ to }5.5\text{ V}$ $T_{min} < T < T_{max}$	100 100	118		dB
I_{IB}	Input bias current	$V_{ICM} = 12\text{ V}$, $V_{sense} = 0$ $T_{min} < T < T_{max}$		100	130 140	μA
		$V_{ICM} = 48\text{ V}$, $V_{sense} = 0$ $T_{min} < T < T_{max}$		200	230 240	
V_{sense}	V_{sense} operating range with $E_g \leq 0.3\%$ ⁽²⁾	TSC2020 $T_{min} < T < T_{max}$			238.5 238.2	mV
		TSC2021 $T_{min} < T < T_{max}$			94.9 94.7	
		TSC2022 $T_{min} < T < T_{max}$			47.1 46.8	
Output						
G	Gain	TSC2020 TSC2021 TSC2022		20 50 100		V/V
E_g	Gain error	$\Delta V_{OUT} = 100\text{ mV to } (V_{CC} - 100\text{ mV})$ $T_{min} < T < T_{max}$		0.01	0.3 0.35	%
$\Delta E_g/\Delta T$	Gain error drift	$T_{min} < T < T_{max}$			3.5	ppm/°C
NLE	Linearity error	$V_{ICM} = -4\text{ to }100\text{ V}$		0.01		%
$V_{CC} - V_{OH}$	Drop voltage output	$I_{source} = 0.2\text{ mA}$ $T_{min} < T < T_{max}$		18	35 45	mV
		$I_{source} = 2\text{ mA}$ $T_{min} < T < T_{max}$		122	155 210	
V_{OL}	Output voltage low	$I_{sink} = 0.2\text{ mA}$ $T_{min} < T < T_{max}$		35	50 70	mV
		$I_{sink} = 2\text{ mA}$ $T_{min} < T < T_{max}$		217	250 400	

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_{OUT}	Output current	Sink mode	8	13.5	20	mA
		$T_{min} < T < T_{max}$	5		24	
		Source mode	10	14.5	25	
		$T_{min} < T < T_{max}$	5		30	
Reg load	Load regulation	$I_{OUT} = -5$ to $+5$ mA		0.2	1.5	$\frac{mV}{mA}$
Offset adjustment						
RT	V_{REF} gain	Voltage applied on one V_{REF} pin		0.5		V/V
Acc	V_{REF} gain error	One V_{REF} pin connected to V_{CC} the other to GND		0.2		%
Dynamic performances						
BW	Small signal -3 dB bandwidth	$R_L = 10$ k Ω , $C_L = 100$ pF	450	700		kHz
		$T_{min} < T < T_{max}$	450			
SR	Slew rate	$C_L = 100$ pF				V/ μ s
		TSC2020, $V_{sense} = 200$ mV	1.4	2		
		TSC2020, $T_{min} < T < T_{max}$	1.2			
		TSC2021, $V_{sense} = 80$ mV	1.7	2.8		
		TSC2021, $T_{min} < T < T_{max}$	1.6			
		TSC2022, $V_{sense} = 40$ mV	2.4	3.9		
TSC2022, $T_{min} < T < T_{max}$	2.2					
EN	Spectral density (RTI) ⁽¹⁾	$f = 1$ kHz		53		nV/ \sqrt{Hz}

1. RTI stands for "Related to input."

2. $V_{sense} = (V_{in+}) - (V_{in-})$.

4 Typical characteristics

TSC2020 is used for typical characteristics, unless otherwise specified.

Figure 3. Input offset production distribution

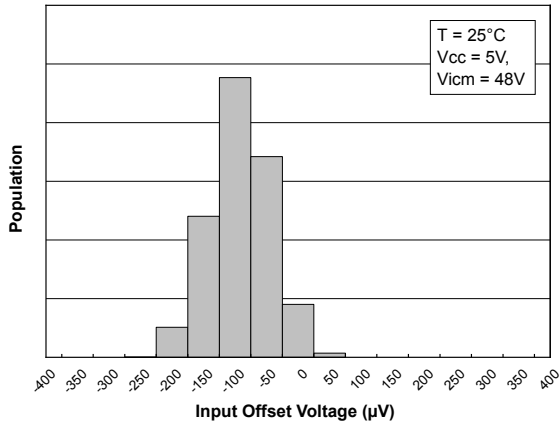


Figure 4. Gain error production distribution

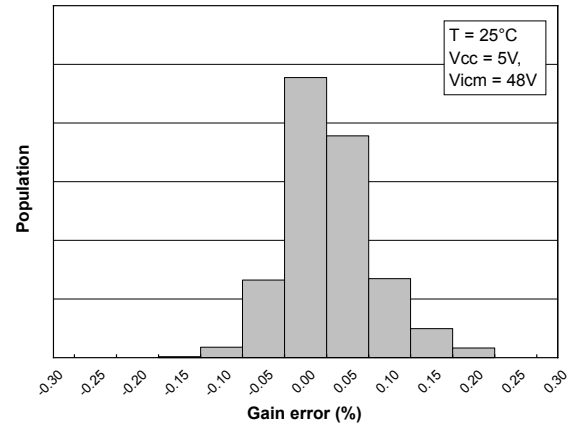


Figure 5. Common-mode rejection ratio production distribution

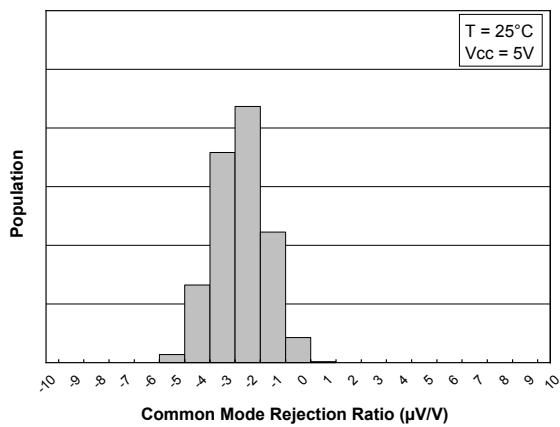


Figure 6. Supply current vs. supply voltage

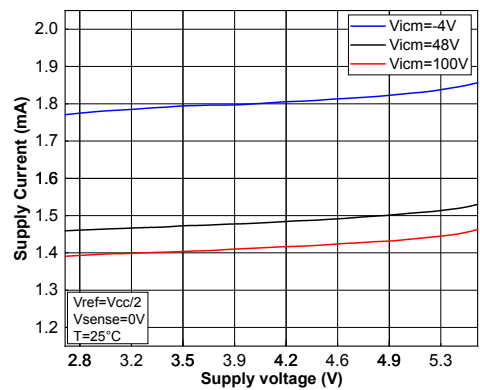


Figure 7. Supply current vs. input common-mode

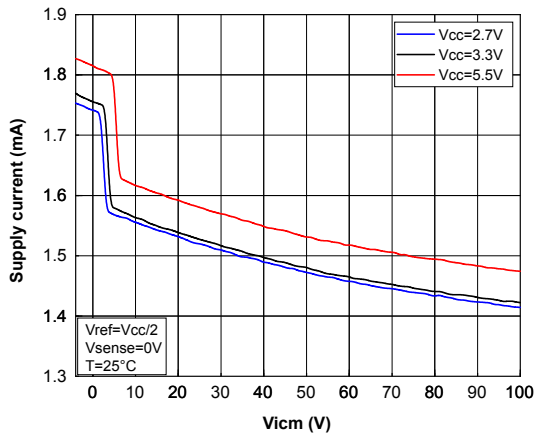


Figure 8. Supply current vs. temperature

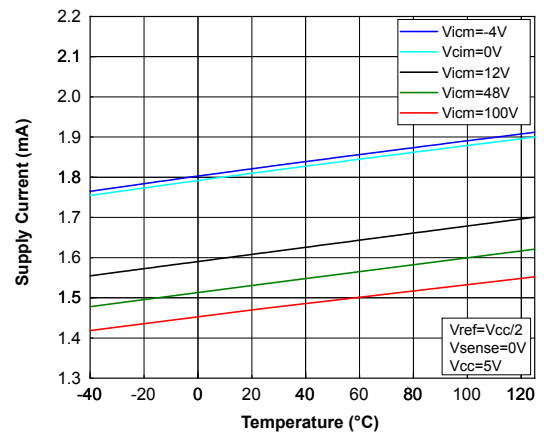


Figure 9. Input bias current vs. input common-mode

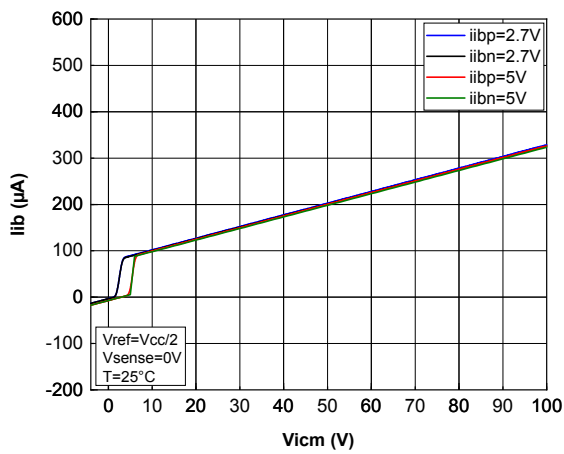


Figure 10. Input bias current vs. temperature

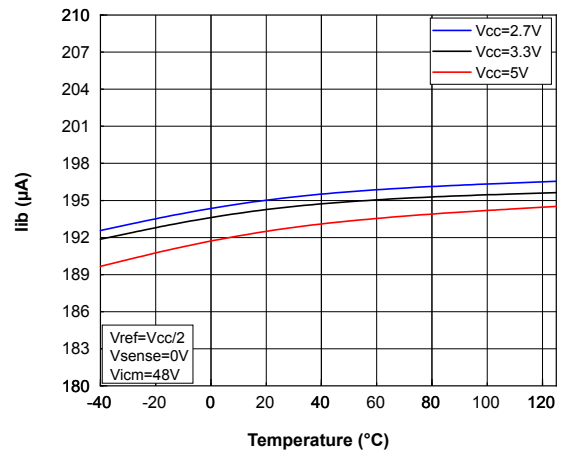


Figure 11. Input bias current vs. input common-mode at VCC = 0 V

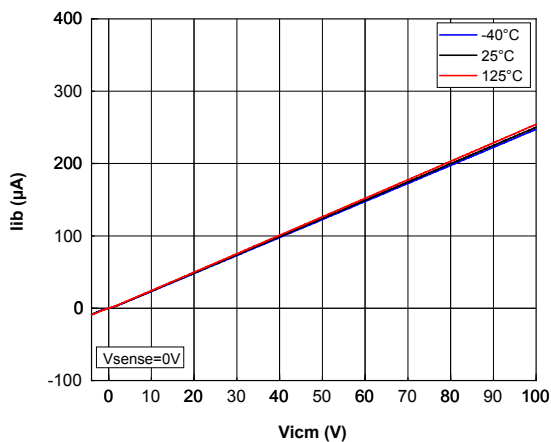


Figure 12. Input bias current vs. Vsense

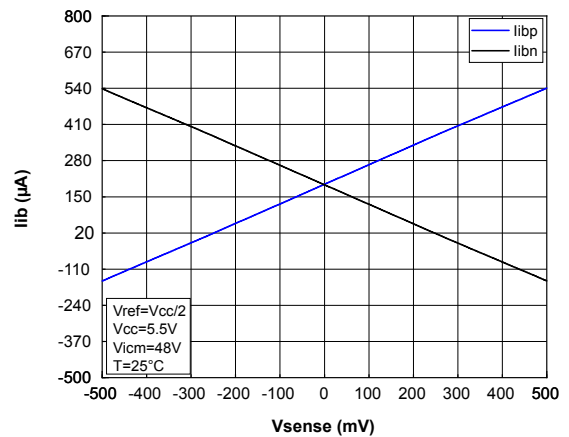


Figure 13. Input offset voltage vs. temperature

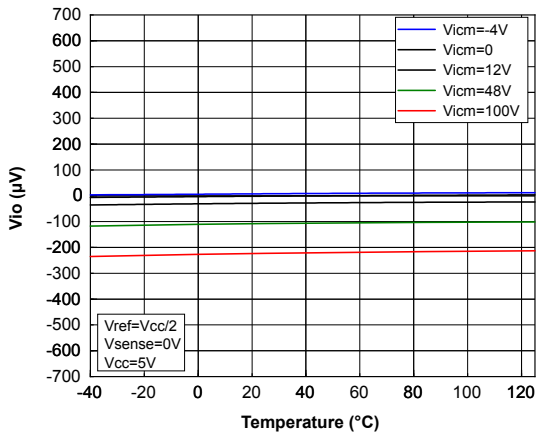


Figure 14. Input offset voltage vs. input common-mode with $V_{CC} = 2.7 V$

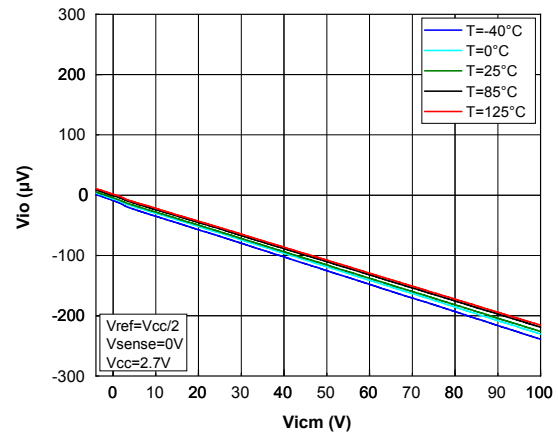


Figure 15. Input offset voltage vs. input common-mode with $V_{CC} = 5.5 V$

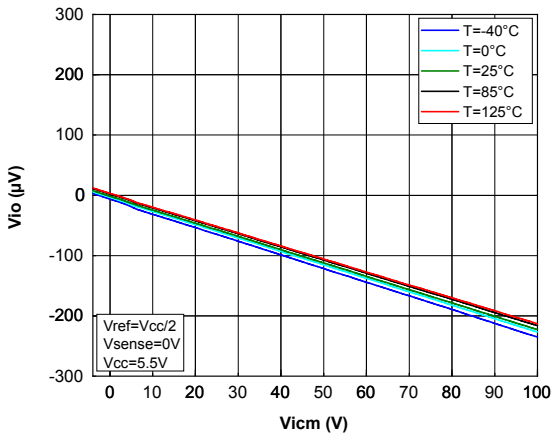


Figure 16. Input offset voltage vs. supply voltage

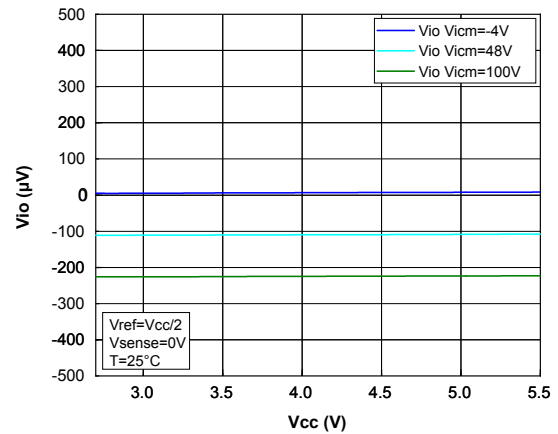


Figure 17. Output current vs. output voltage

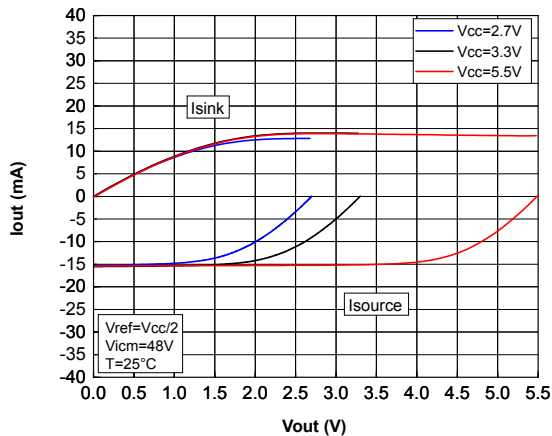


Figure 18. Output current vs. temperature with $V_{CC} = 5.5 V$

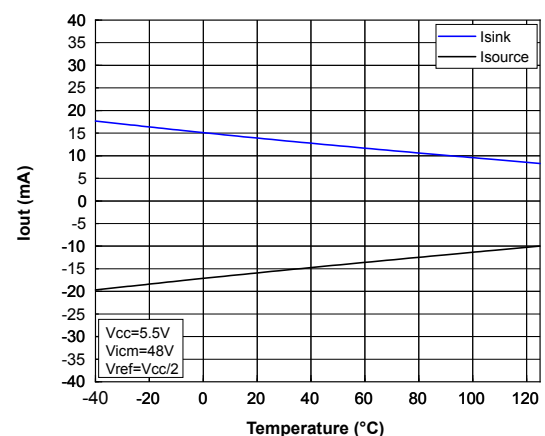


Figure 19. Output current vs. temperature with $V_{CC} = 2.7\text{ V}$

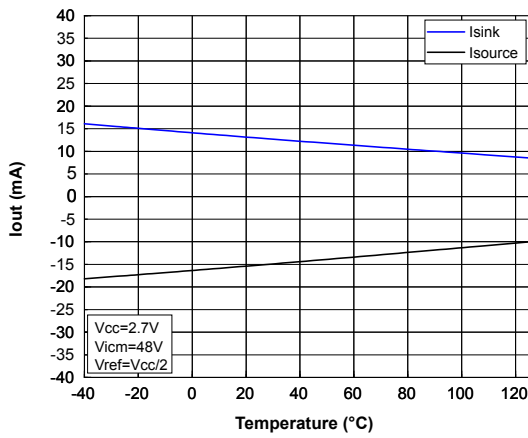


Figure 20. V_{OH} and V_{OL} vs. temperature with $V_{CC} = 5.5\text{ V}$

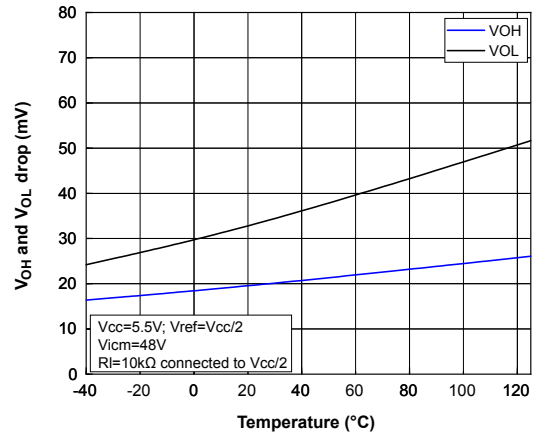


Figure 21. V_{OH} and V_{OL} vs. temperature with $V_{CC} = 2.7\text{ V}$

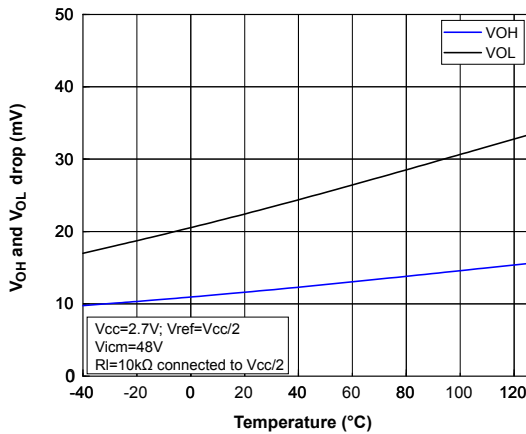


Figure 22. Linearity vs. Vense with $V_{CC} = 5.5\text{ V}$

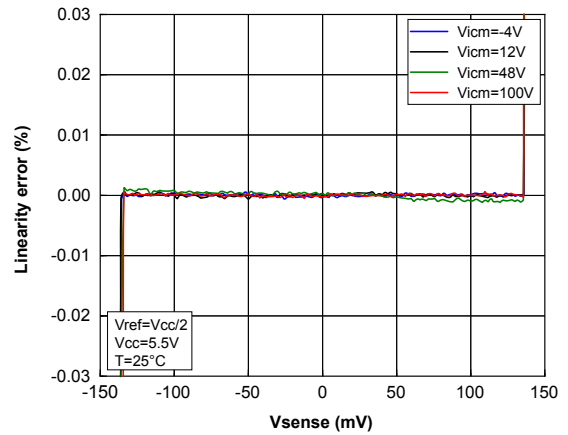


Figure 23. Linearity vs. Vense and temperature

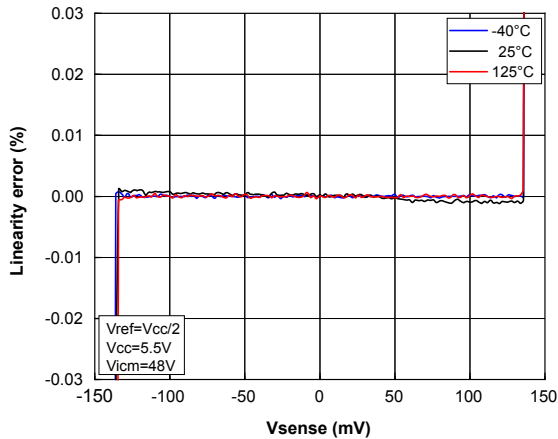


Figure 24. Gain error vs. input common-mode

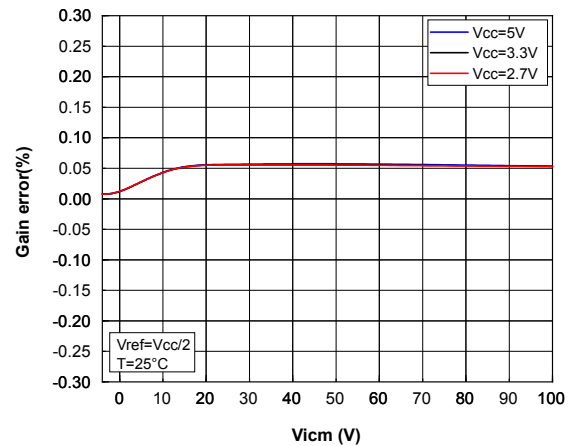


Figure 25. Gain error vs. input common mode at $V_{CC} = 5\text{ V}$

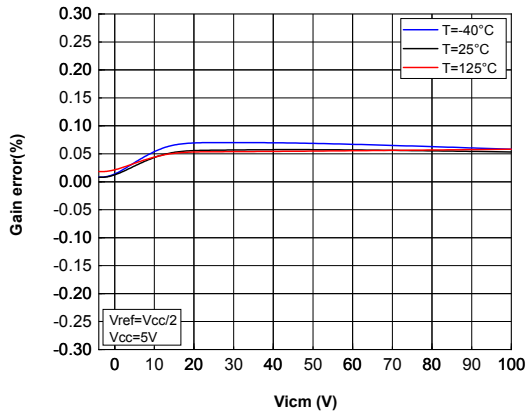


Figure 26. Load regulation with $V_{CC} = 5\text{ V}$

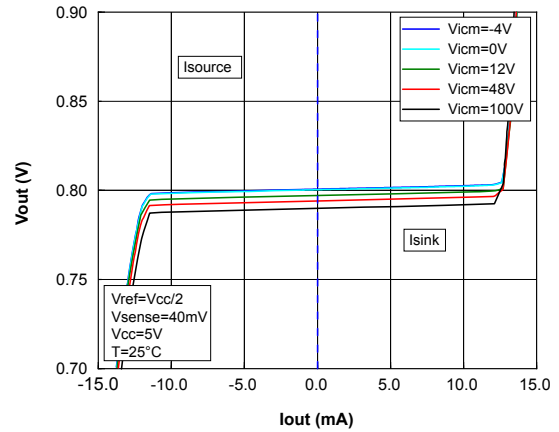


Figure 27. Gain vs. frequency

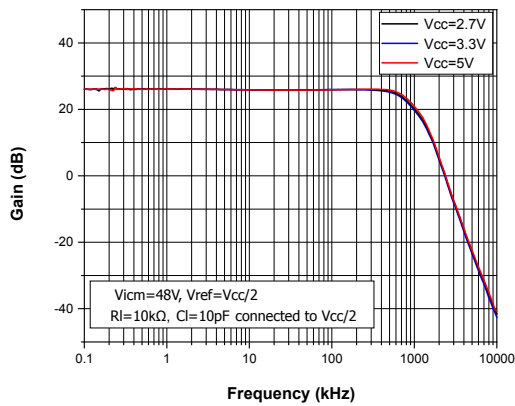


Figure 28. Gain vs. frequency different capacitive load

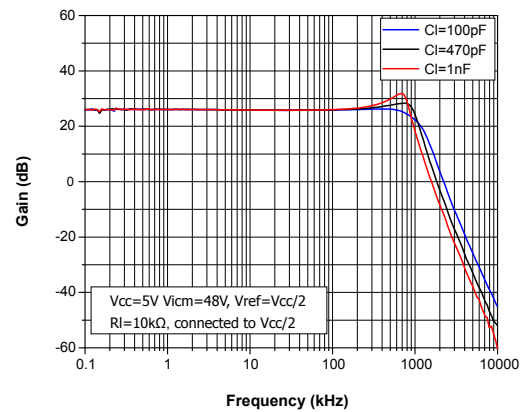


Figure 29. Bandwidth vs. input common-mode

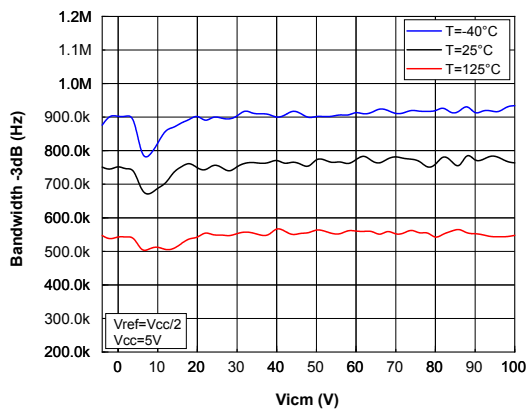


Figure 30. Overshoot vs. capacitive load

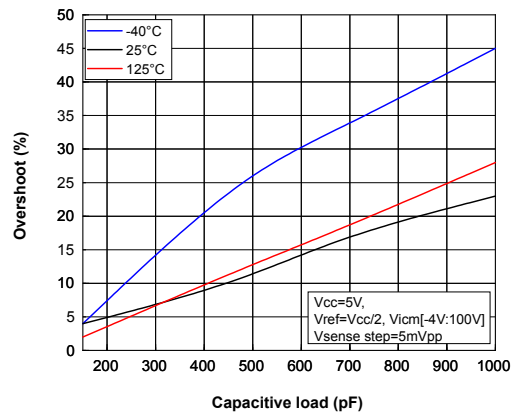


Figure 31. Small signal response with $V_{CC} = 5\text{ V}$

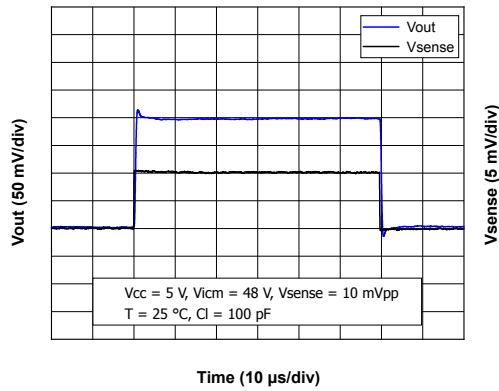


Figure 32. Large signal response with $V_{CC} = 5\text{ V}$

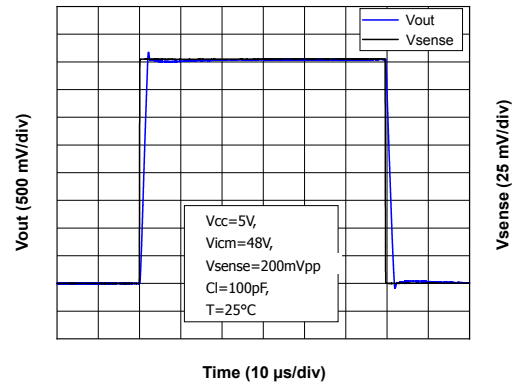


Figure 33. Positive settling time 1%

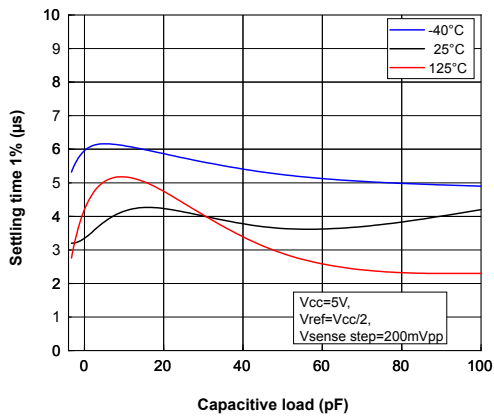


Figure 34. Negative settling time 1%

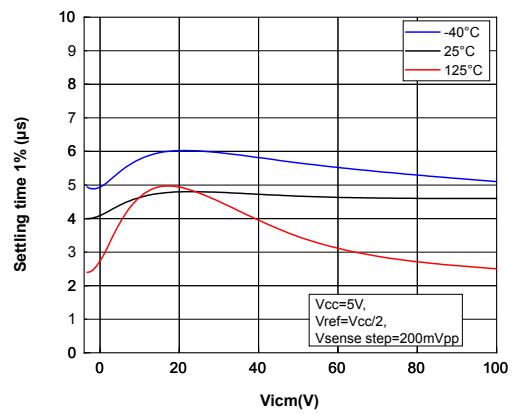


Figure 35. 48 V common-mode positive step response recovery

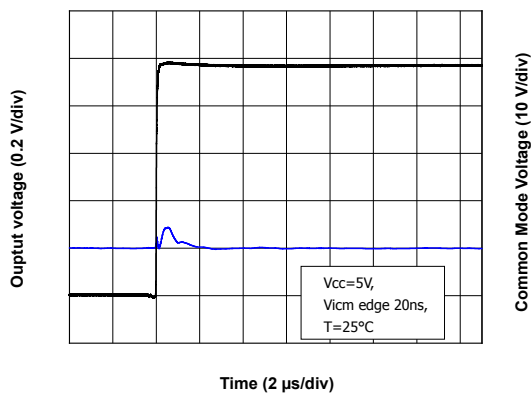


Figure 36. 48 V common-mode negative step response recovery

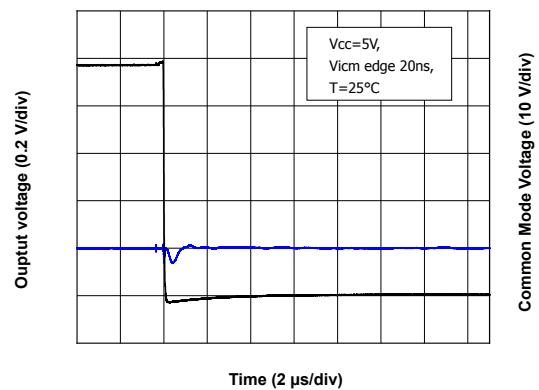


Figure 37. 100 V common-mode positive step response recovery

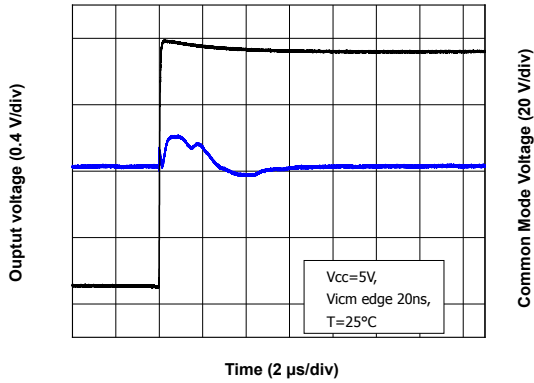


Figure 38. 100 V common-mode negative step response recovery

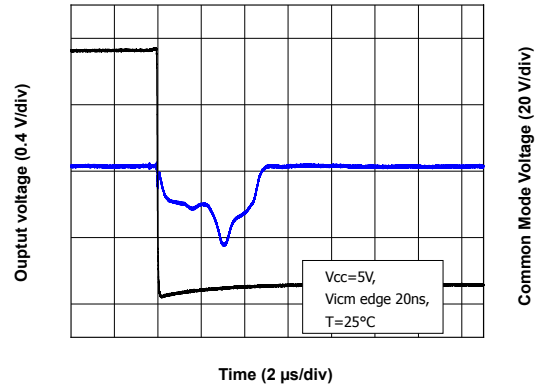


Figure 39. PSRR vs. frequency

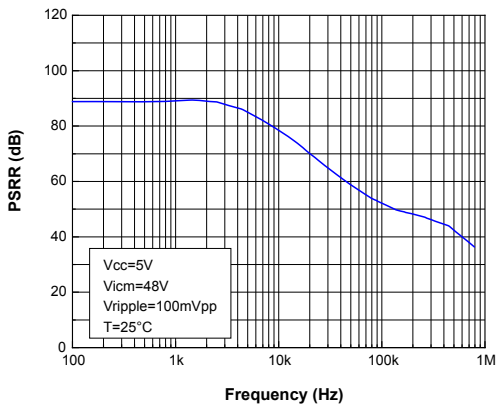


Figure 40. CMRR vs. frequency

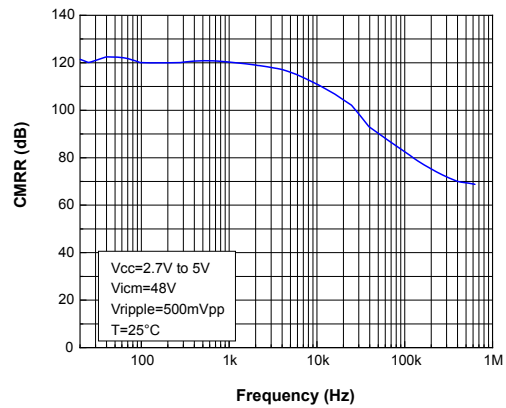


Figure 41. Positive overvoltage recovery

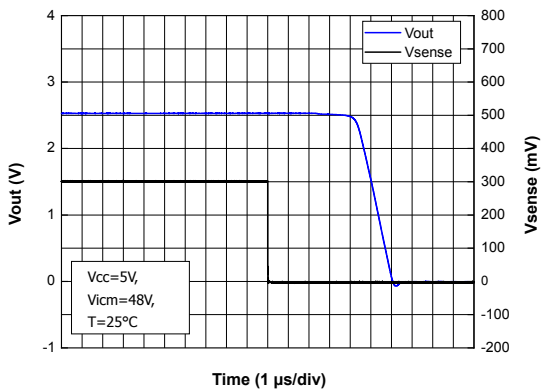


Figure 42. Negative overvoltage recovery

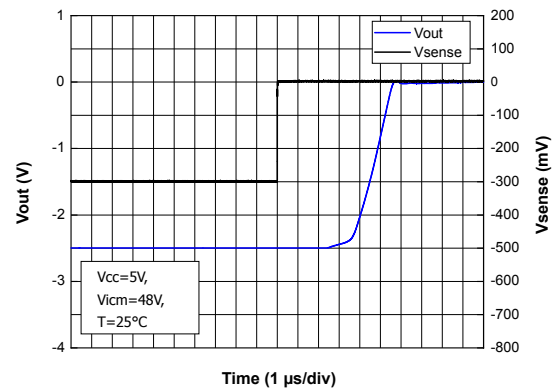


Figure 43. Overvoltage recovery vs. V_{icm} , $V_{CC} = 5\text{ V}$

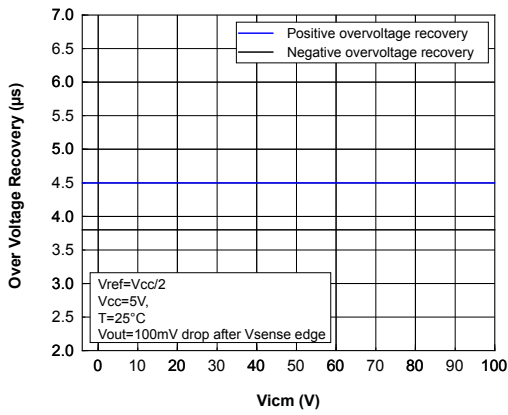


Figure 44. Noise vs. frequency

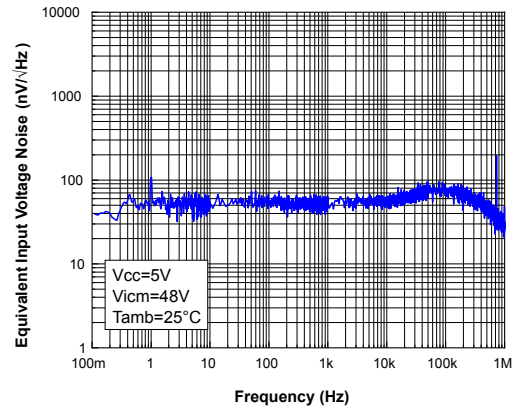


Figure 45. 0.1 Hz to 10 Hz voltage noise

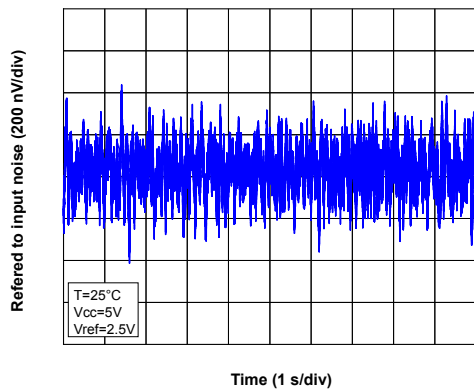


Figure 46. Power up time delay

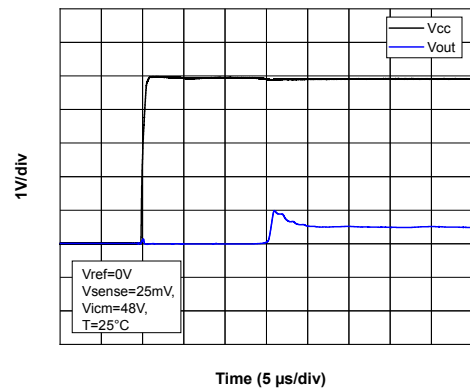
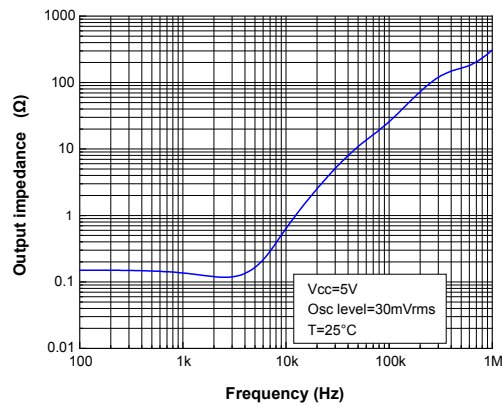


Figure 47. Output impedance vs. frequency



5 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

5.1 SO8 package information

Figure 48. SO8 package outline

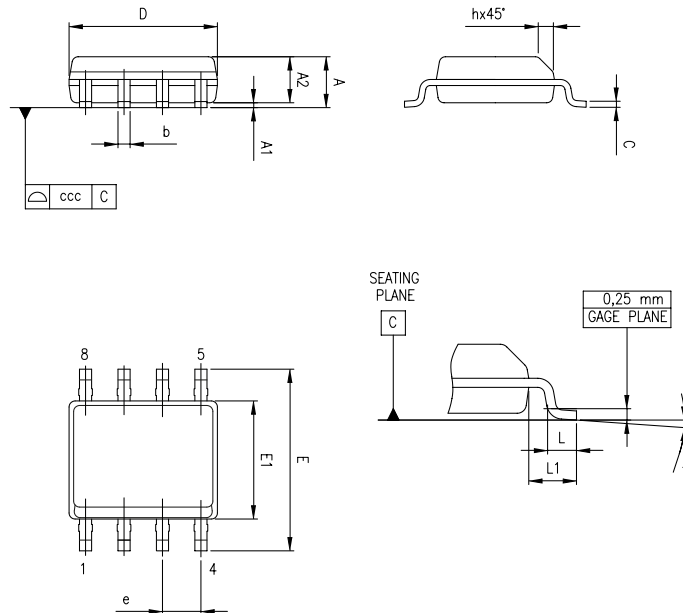
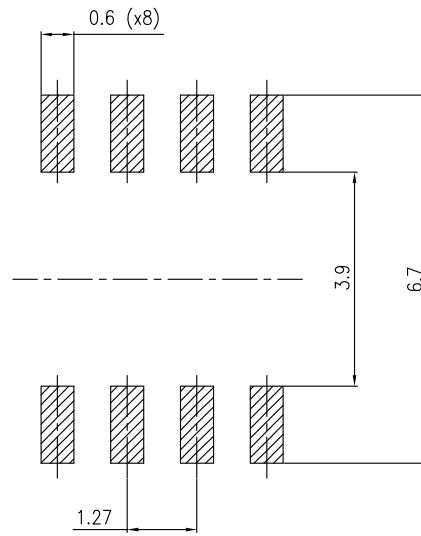


Table 6. SO8 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.069
A1	0.10		0.25	0.04		0.010
A2	1.25			0.049		
b	0.28	0.40	0.48	0.011	0.016	0.019
c	0.17		0.23	0.007		0.010
D	4.80	4.90	5.00	0.189	0.193	0.197
E	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
e		1.27			0.050	
h	0.25		0.50	0.010		0.020
L	0.40	0.635	1.27	0.016		0.050
L1		1.04			0.040	
k	1°		8°	1°		8°
ccc			0.10			0.004

Figure 49. SO8 recommended footprint



5.2 MiniSO8 package information

Figure 50. MiniSO8 package outline

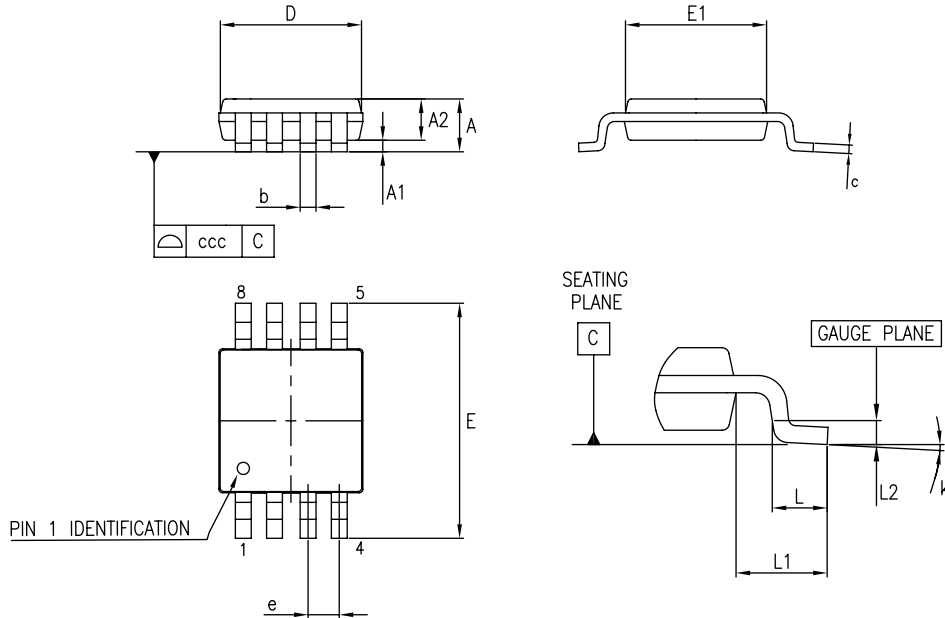
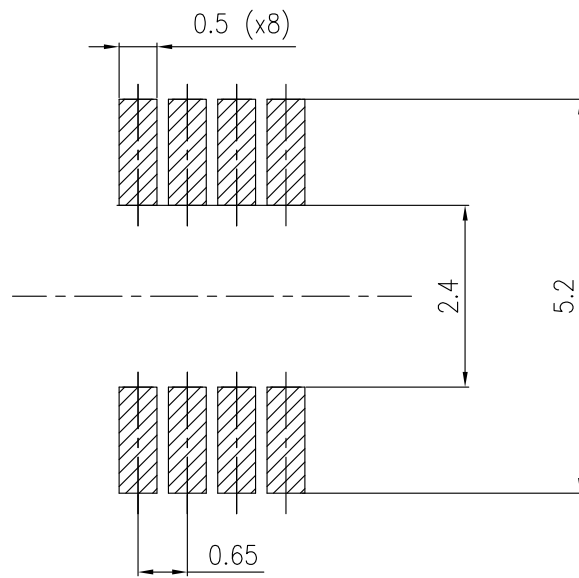


Table 7. MiniSO8 mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.1			0.043
A1	0		0.15	0		0.006
A2	0.75	0.85	0.95	0.03	0.033	0.037
b	0.22		0.4	0.009		0.016
c	0.08		0.23	0.003		0.009
D	2.8	3	3.2	0.11	0.118	0.126
E	4.65	4.9	5.15	0.183	0.193	0.203
E1	2.8	3	3.1	0.11	0.118	0.122
e		0.65			0.026	
L	0.4	0.6	0.8	0.016	0.024	0.031
L1		0.95			0.037	
L2		0.25			0.01	
k	0°		8°	0°		8°
ccc			0.1			0.004

Figure 51. MiniSO8 recommended footprint



6 Ordering information

Table 8. Order codes

Order code	Gain (V/V)	Package	Packaging	Marking
TSC2020IDT	20	SO8	Tape & Reel	TSC2020
TSC2020IYDT ⁽¹⁾				TSC2020Y
TSC2020IST		MiniSO8		O129
TSC2020IYST ⁽¹⁾				O132
TSC2021IDT	50	SO8		TSC2021
TSC2021IYDT ⁽¹⁾				TSC2021Y
TSC2021IST		MiniSO8		O130
TSC2021IYST ⁽¹⁾				O133
TSC2022IDT	100	SO8		TSC2022
TSC2022IYDT ⁽¹⁾				TSC2022Y
TSC2022IST		MiniSO8		O131
TSC2022IYST ⁽¹⁾				O134

1. Qualified and characterized according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 & Q002 or equivalent.

Revision history

Table 9. Document revision history

Date	Revision	Changes
22-Sep-2023	1	Initial release.
20-May-2024	2	Added new TSC2021 and TSC2022 order codes in Table 8 .

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